

Part Number: XZM2ACY79W

3.8x2.0mm DOME LENS SMD CHIP LED LAMP

PRELIMINARY SPEC

Features

- \bullet 3.8mmx2.0mm SMT LED, 3.2mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package : 500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

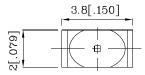


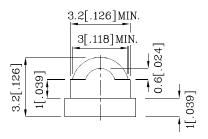


Notes:

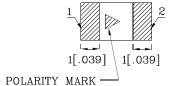
- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.2(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Rating (TA=25°C)	M2ACY (AlInGaP)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V
Forward Current	IF	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA
Power Dissipation	Рт	75	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	C









Operating Characteristic (TA=25°C)	M2ACY (AlInGaP)	Unit	
Forward Voltage (Typ.) (IF=20mA)	VF	2.0	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength of Peak Emission (Typ.) (IF=20mA)	λΡ	590	nm
Wavelength of Dominant Emission (Typ.) (IF=20mA)	λ D	589	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	20	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	45	pF

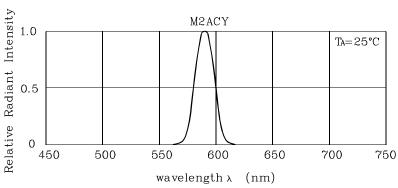
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		$\begin{array}{c} Wave length \\ nm \\ \lambda \ P \end{array}$	Viewing Angle 2 0 1/2
				min.	typ.		
XZM2ACY79W	Yellow	AlInGaP	Water Clear	650	1295	590	60° (H) 35° (V)
Published Date : JA	N 12,2009	Drawing	g No : XDSB2805	V1	Checl	xed : B.L.LIU	P.1/4



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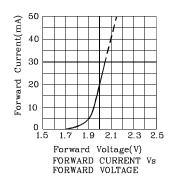


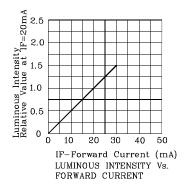
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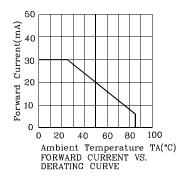


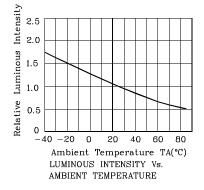
RELATIVE INTENSITY Vs. WAVELENGTH

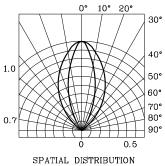
❖ M2ACY









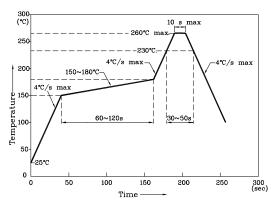




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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

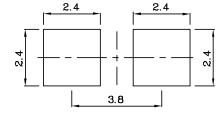
Reflow Soldering Profile For Lead-free SMT Process.

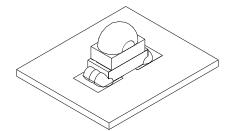


- NOTES:
 - Maximum soldering temperature should not exceed 260°c.
 - 2. Recommended reflow temperature: 145°c-260°c.
 - Do not put stress to the epoxy resin during high temperatures conditions.

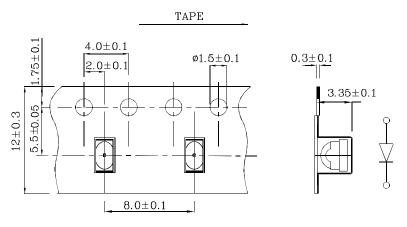
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

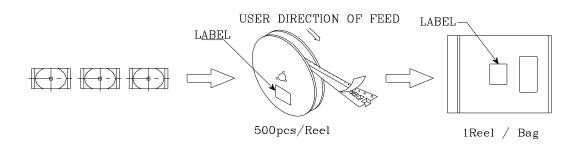


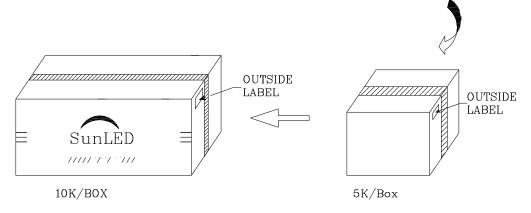


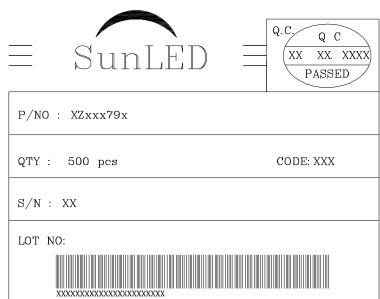
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PACKING & LABEL SPECIFICATIONS

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RoHS Compliant